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Dated: December 22, 2004 Signature: _____

(Marcus J. Millet)

Docket No.: TESSERA 3.0-196 DIV
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Smith et al.

Application No.: 10/685,361

Group Art Unit: 2812

Filed: October 14, 2003

Examiner: L. A. Gurley

For: SEMICONDUCTOR CHIP PACKAGE WITH
INTERCONNECT STRUCTURE

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

**REQUEST FOR CONSIDERATION OF INFORMATION
UNDER 37 C.F.R. § 1.97 (C)**

Dear Sir:

It is respectfully requested that the references cited in the enclosed form be considered pursuant to 37 C.F.R. § 1.97(c). Please charge deposit account No. 12-1095 in the amount of \$180.00 pursuant to 37 C.F.R. § 1.17(p). In the event that any additional fee is due in connection with the present request, the same should be charged to our deposit account No. 12-1095.

Dated: December 22, 2004

Respectfully submitted,

By _____

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12/28/2004 KBETEMAI 00000027 121095 10685361

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